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NCP4371

Qualcomm Quick Charge™ 3.0 HVDCCP Controller

NCP4371 is a USB secondary side fast-charging controller, supporting Qualcomm Quick Charge 3.0 (QC 3.0) High Voltage Dedicated Charging Port (HVDCCP) Class A and Class B specification. NCP4371 allows for selection of the output voltage of an AC-DC USB adapter based on commands from the Portable Device (PD) being powered. Selecting a higher charging voltage will reduce the charging current for a given power level resulting in reduced IR drops and increased system efficiency. Another advantage of QC3.0 is a decreased battery charging time and a reduced PD system cost thanks to the ability to select an optimum charging voltage. This eliminates the need for costly DC-DC converters within the PD. The USB-bus voltage can be controlled in discreet steps from 3.6 V up to 20 V. The output current is limited not to exceed maximum allowable power level.

The NCP4371 resides at the secondary (isolated) side of the adapter. It includes voltage and current feedback regulation eliminating the need for a shunt regulator such as TL431.

The NCP4371 provides charging current limits down to $V_{BUS} = 2.2$ V protecting the portable device from excessive currents in case of a soft short-circuit condition.

The NCP4371 integrates a safe-discharge circuitry to quickly and reliably discharge output capacitors in case the USB cable is unplugged or connected to a 5 V only USB port.

Features

- Supports Qualcomm Quick Charge 3.0 HVDCCP Class A/B
- Output Voltage Can be Configured in Discreet Steps from
 - ◆ Class A: 3.6 V up to 12 V
 - ◆ Class B: 3.6 V up to 20 V
- Compatible with USB Battery Charging Specification Revision 1.2 (USB BC1.2)
- Constant Voltage and Constant Current Regulation
- Soft Short-Circuit Current Limitation Down to $V_{BUS} = 2.2$ V
- Removes a Need for the Secondary Side Shunt Regulator such as TL431
- Output Capacitor Safe-Discharge Circuitry at Cable Unplug
- Fast Dynamic Response
- Built-in Power Limiting Function
- Low Supply Current
- Wide Operating Input Voltage Range: 2.2 V to 28 V
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Fast Charging AC/DC Adapters for Smart Phones, Tablets and Other Portable Devices



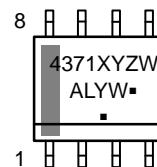
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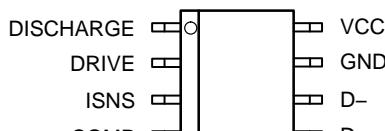
MARKING DIAGRAM



4371XYZW = Specific Device Code
(See Device Options Table)

A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb-Free Package

PIN CONNECTIONS



(Top View)

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 13 of this data sheet.

NCP4371

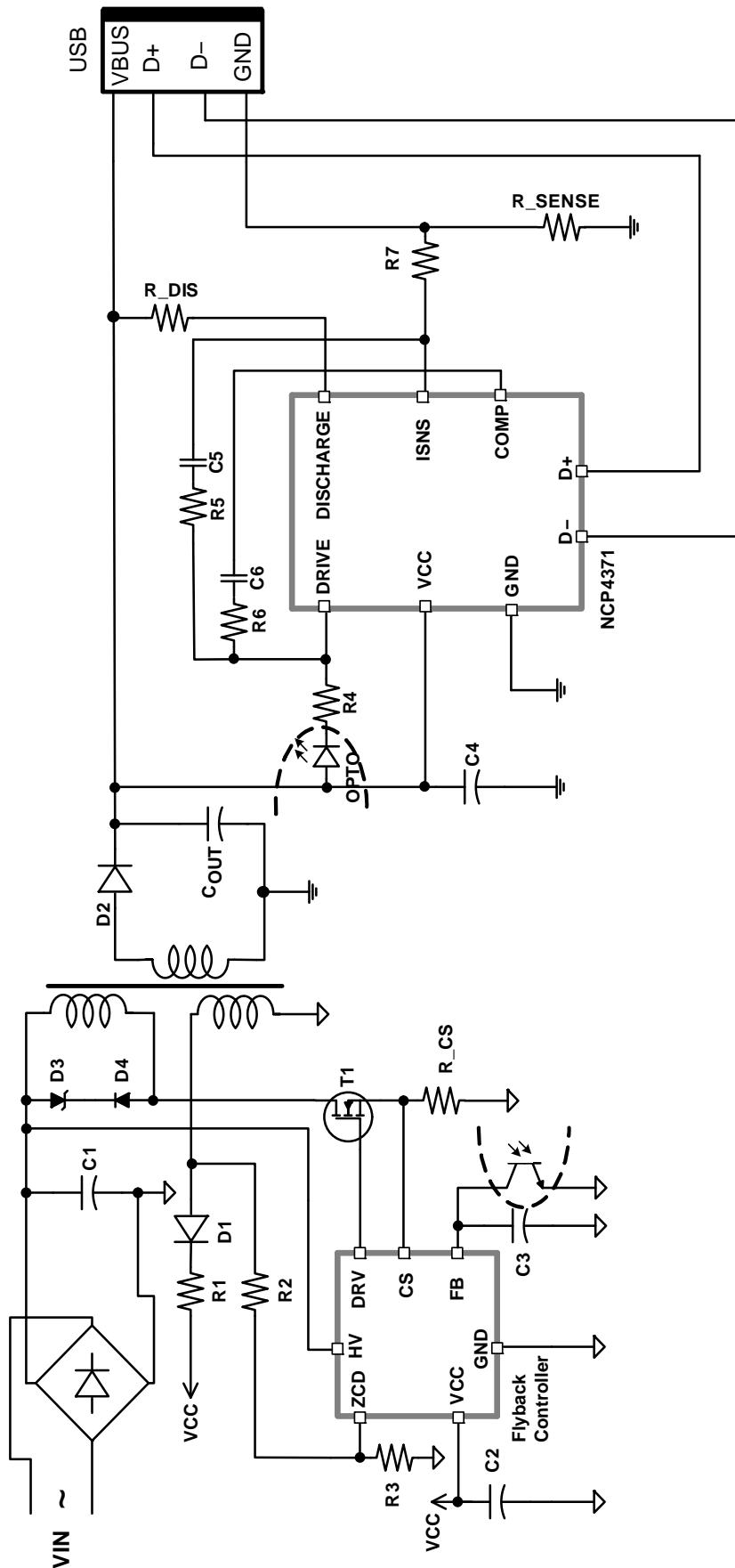


Figure 1. Typical Application Schematic

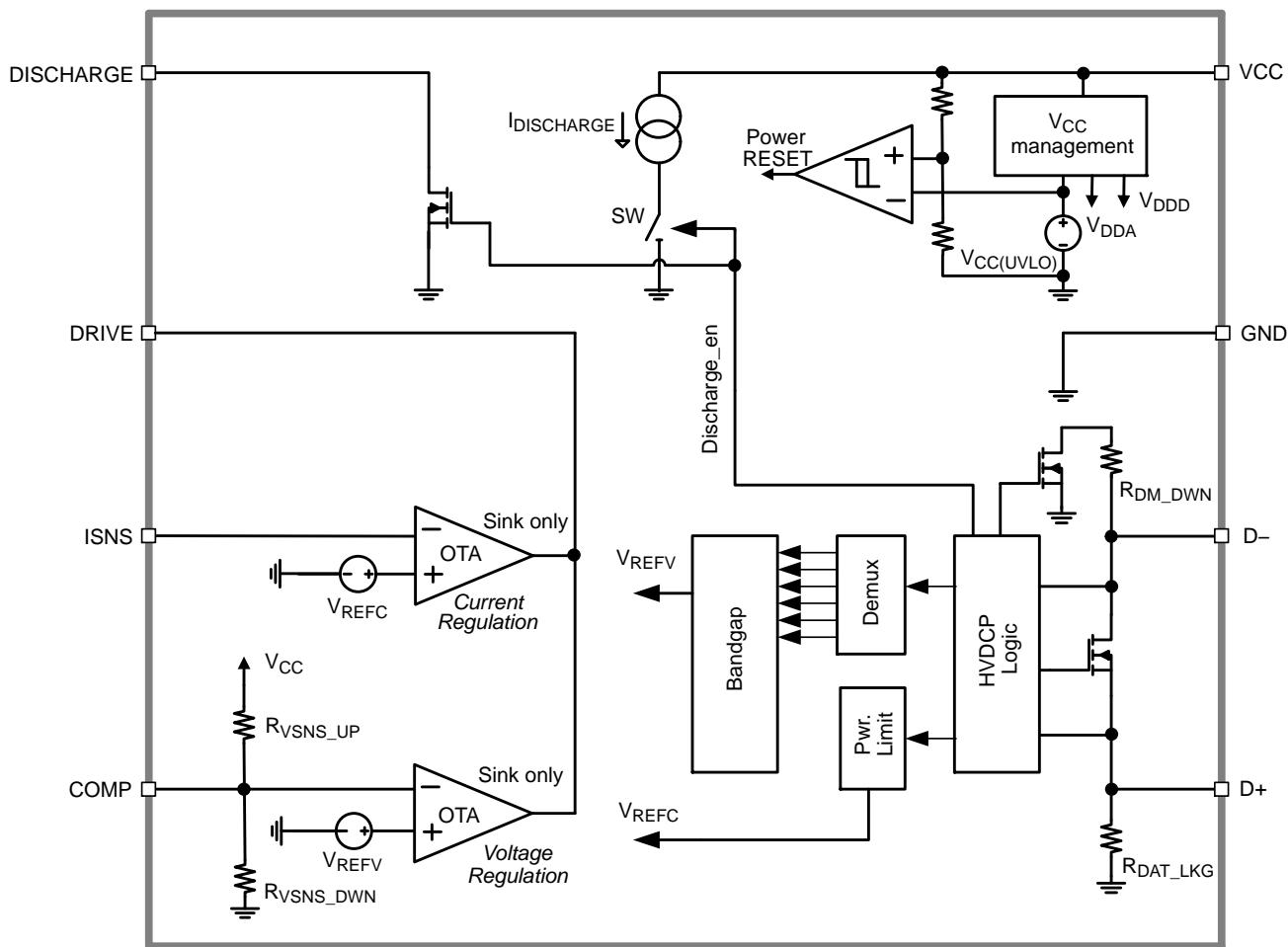


Figure 2. Simplified Block Diagram

Table 1. PIN FUNCTION DESCRIPTION

Pin No.	Pin Name	Description
1	DISCHARGE	This output is used to safely discharge V_{BUS} output capacitors when an unplug event is detected
2	DRIVE	Output of current sinking OTA amplifier or amplifiers driving feedback optocoupler's LED. Connect here compensation network (networks) as well.
3	ISNS	Current sensing input for output current regulation, connect it to shunt resistor in ground branch.
4	COMP	Compensation pin of output voltage regulation, connected to a feedback compensation network.
5	D+	USB D+ Data Line Input
6	D-	USB D- Data Line Input
7	GND	Ground
8	VCC	Supply voltage pin

Table 2. MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Supply Voltage	V_{CC}	-0.3 to 28.0 ±100	V mA
DISCHARGE pin	$V_{DISCHARGE}$	-0.3 to V_{CC} +500/-40	V mA
DRIVE pin	V_{DRIVE}	-0.3 to V_{CC} +100/-90	V mA
D+, D-, VSNS, ISNS Input Voltage	V_{D+} , V_{D-} , V_{VSNS} , V_{iSNS}	-0.3 to 5.5 ±100	V mA
Junction to Air Thermal Resistance, SOIC8	$R_{\theta J-A_SOIC8}$	160	°C/W
Maximum Junction Temperature	T_{JMAX}	125	°C
Storage Temperature	T_{STG}	-60 to 150	°C
ESD Capability, Human Body Model (Notes 1, 4)	ESD_{HBM}	6000	V
ESD Capability, Machine Model (Note 1)	ESD_{MM}	200	V
ESD Capability, Charged Device Model (Note 1)	ESD_{CDM}	750	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Refer to ELECTRICAL CHARACTERISTICS and APPLICATION INFORMATION for Safe Operating Area.

2. This device series incorporates ESD protection and is tested by the following methods:

ESD Human Body Model tested per AEC-Q100-002 (EIA/JESD22-A114)

ESD Machine Model tested per AEC-Q100-003 (EIA/JESD22-A115)

ESD Charged Device Model per JEDEC Standard JESD22-C101D

Latchup Current Maximum Rating <100 mA per JEDEC standard: JESD78 with respect to max. ratings table values

3. For information, please refer to our Soldering and Mounting Techniques Reference Manual, SOLDERRM/D

4. D+ vs. D- pin capability HBM 2500 V

Table 3. ELECTRICAL CHARACTERISTICS

-40°C ≤ T_J ≤ 125°C; $V_{CC} = 5$ V; unless otherwise noted. Typical values are at $T_J = +25$ °C.

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
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SUPPLY

Minimum Operating Input Voltage	V_{CC} voltage at which current limiting OTA is enabled	$V_{CC(min)}$	-	-	2.2	V
V_{CC} HVDPC Logic Enable	V_{CC} increasing level at which the HVDPC commands are accepted	$V_{CC(ON)}$	2.9	3.2	3.4	V
V_{CC} HVDPC Logic Disable	V_{CC} decreasing level at which the HVDPC commands are stopped to be accepted	$V_{CC(OFF)}$	2.7	3.0	3.2	V
Quiescent Current		I_{CC}			300	µA

VOLTAGE CONTROL LOOP OTA

Transconductance	Sink current only	g_{mv}	-	1	-	S
Voltage Control Reference Voltage	Nominal $V_{BUS}=5$ V	V_{REFV}	1.21	1.25	1.29	V
Sink Current Capability		I_{SINKV}	2.0			mA
Output Voltage Sense Divider Resistor, Pull-Up		R_{VSNS_UP}		66		kΩ
Output Voltage Sense Divider Resistor, Pull-Down		R_{VSNS_DWN}		24		kΩ

CURRENT CONTROL LOOP OTA

Transconductance	Sink current only	g_{mc}	-	3	-	S
Current Control Reference Voltage	Current limit A reference set-point Current limit B reference set-point Current limit C reference set-point Current limit D reference set-point Current limit E reference set-point Current limit F reference set-point Current limit G reference set-point Current limit H reference set-point	$V_{REFC(A)}$ $V_{REFC(B)}$ $V_{REFC(C)}$ $V_{REFC(D)}$ $V_{REFC(E)}$ $V_{REFC(F)}$ $V_{REFC(G)}$ $V_{REFC(H)}$	10 12 18 24 29 34 40 53	14 17 22 28 33 38 44 57	18 21 26 32 37 42 48 61	mV

Table 3. ELECTRICAL CHARACTERISTICS-40°C ≤ TJ ≤ 125°C; V_{CC} = 5 V; unless otherwise noted. Typical values are at T_J = +25°C.

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
CURRENT CONTROL LOOP OTA						
Sink Current Capability		I _{SINKC}	2.0			mA
HVDPC						
Output Voltage Selection Reference		V _{SEL_REF}	1.8	2	2.2	V
Data Detect Voltage		V _{DAT_REF}	0.25	0.325	0.4	V
Data Line Leakage Resistance		R _{DAT_LKG}	300	–	1500	kΩ
D– Pull–Down Resistance		R _{DM_DWN}	14.25	19.53	24.8	kΩ
D+ to D– Resistance During DCP Mode		R _{DCP_DAT}			45	Ω
OUTPUT CAPACITOR DISCHARGER						
Discharge Comparator OFF Voltage	V _{BUS_REF} = 5 V, V _{DIS(OFF)} sensed at V _{CC} pin	V _{DIS(OFF)}		5.2		mV
V _{CC} Discharge Current	Discharge current of the internal current sink at the V _{CC} pin	I _{DIS(VCC)}			90	mA
DISCHARGE Pin Maximum Sink Current	Maximum sink current of the DISCHARGE pin Minimum recommended external discharge resistor value connected from V _{BUS} to DISCHARGE pin is R _{DIS} ≥=70 Ω (Class A) R _{DIS} ≥=120 Ω (Class B)	I _{DIS(EXT)}		150		mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS

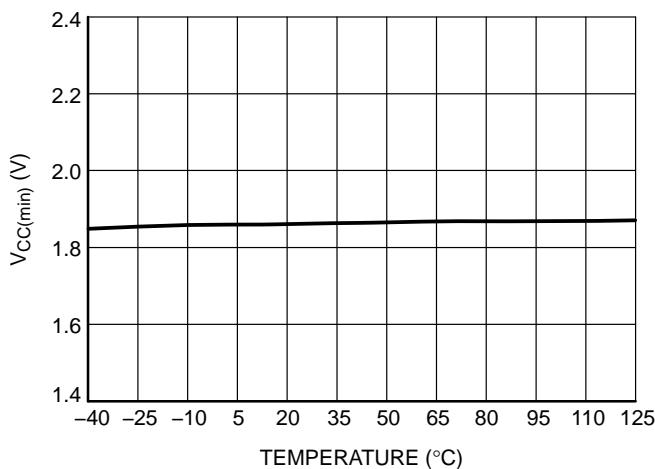


Figure 3. V_{CC} Minimum Operating Input Voltage, $V_{CC(min)}$

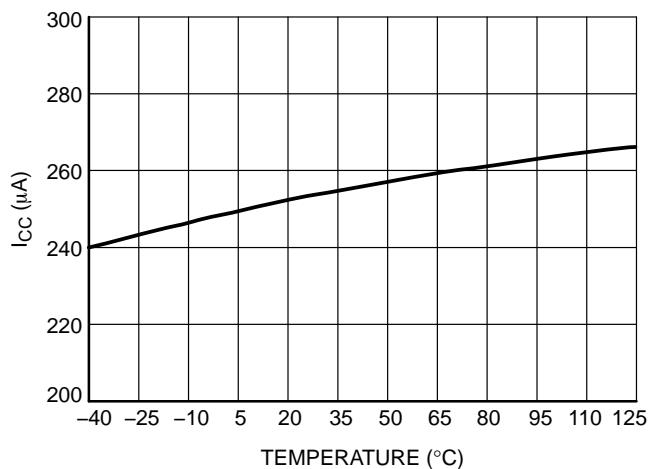


Figure 4. Quiescent Current, I_{CC}

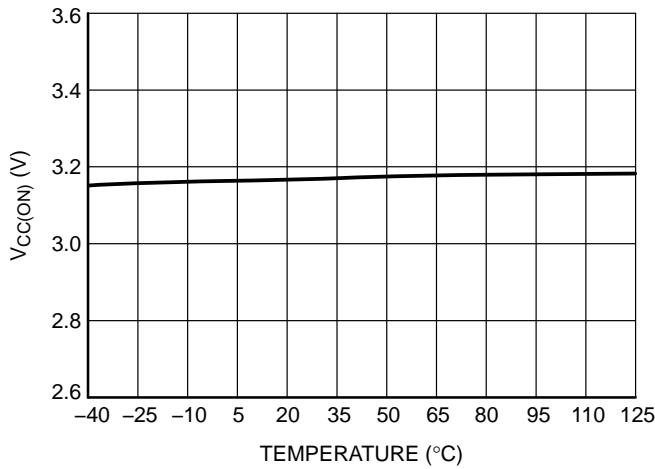


Figure 5. V_{CC} HVDPC Logic Enable, $V_{CC(ON)}$

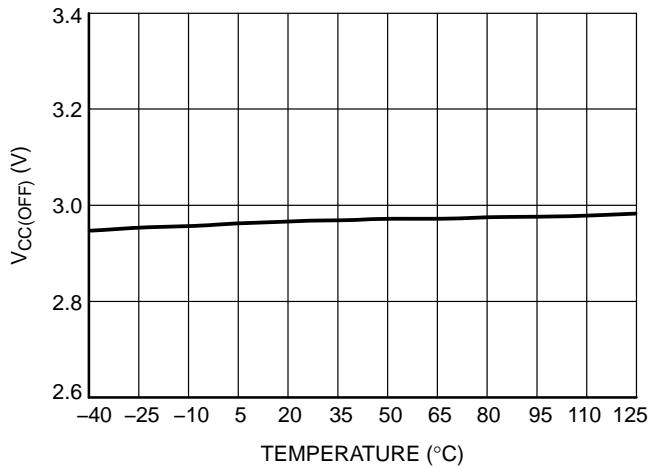


Figure 6. V_{CC} HVDPC Logic Disable, $V_{CC(OFF)}$

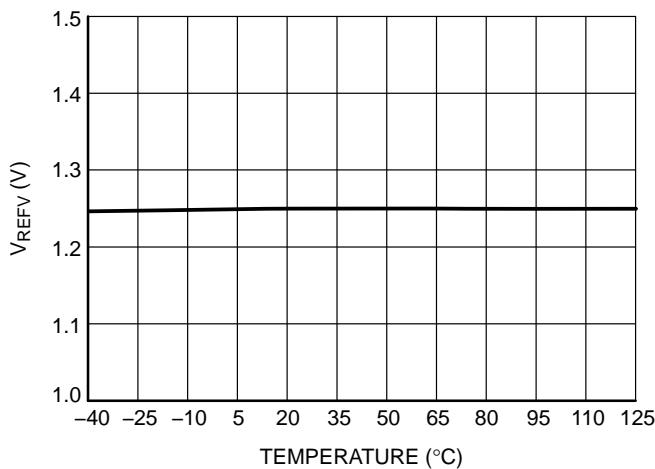


Figure 7. Voltage Control Reference Voltage, V_{REFV}

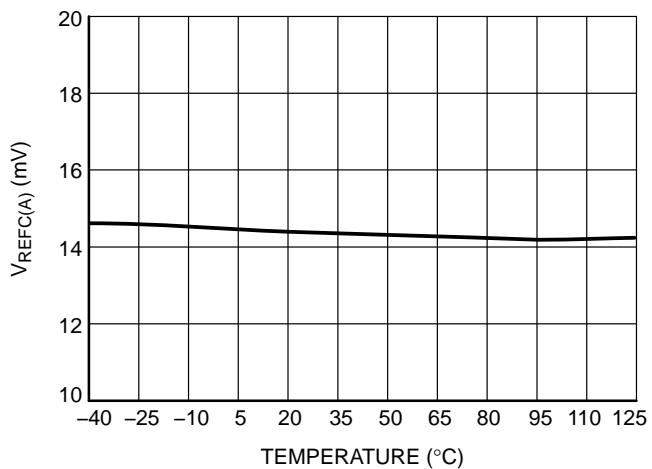
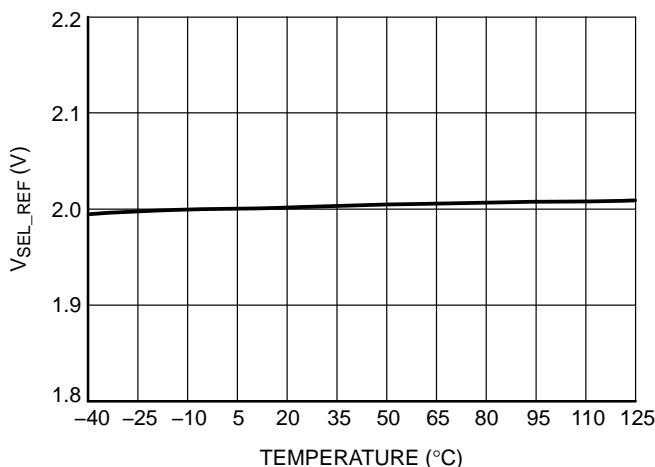
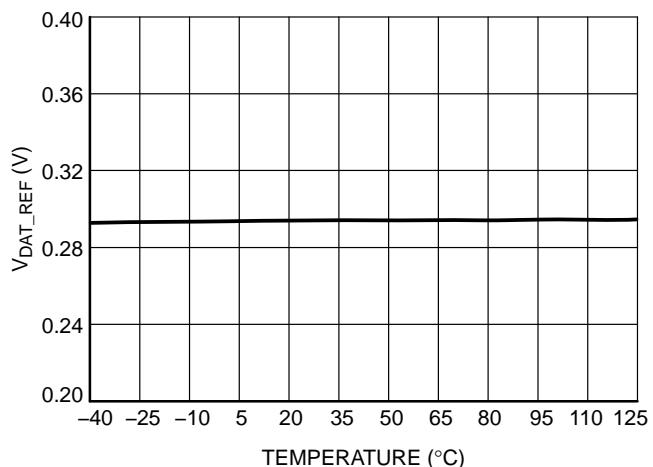
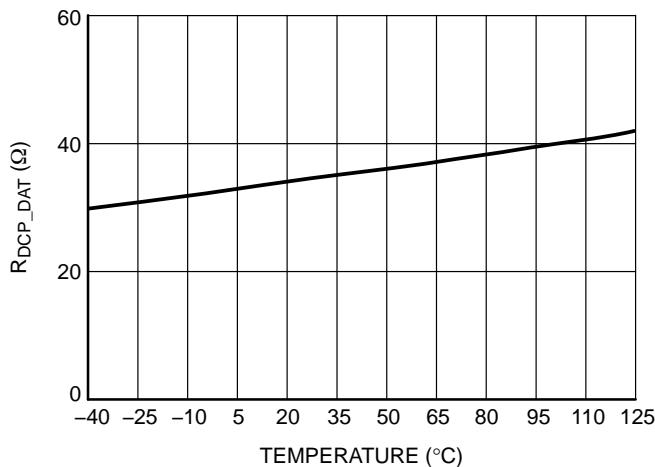
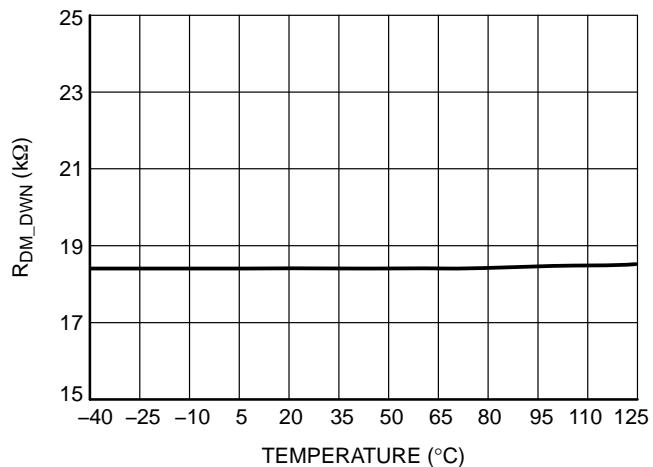
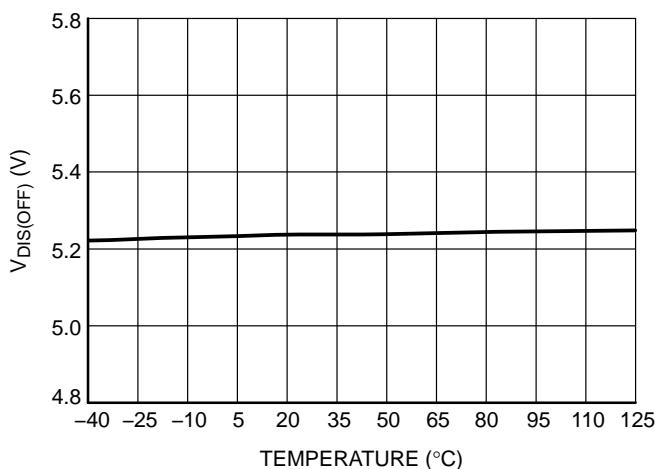
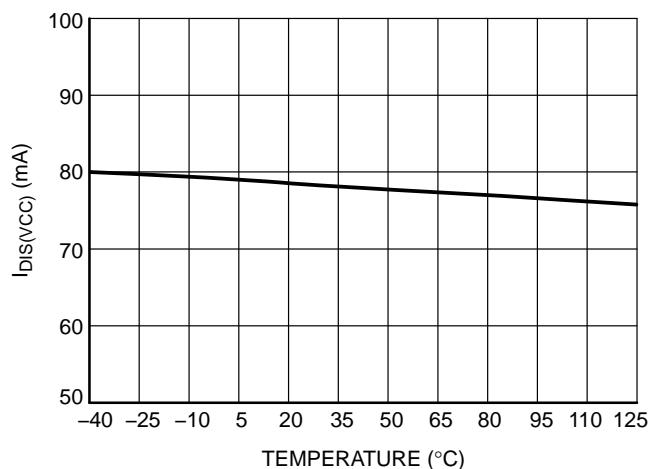


Figure 8. Current Control Reference Voltage, $V_{REFC(A)}$

TYPICAL CHARACTERISTICS

Figure 9. Output Voltage Selection Reference, V_{SEL_REF} Figure 10. Data Detect Voltage, V_{DAT_REF} Figure 11. D+ to D- Resistance During DCP Mode, R_{DCP_DAT} Figure 12. D- Pull-Down Resistance, R_{DM_DWN} Figure 13. Discharge Comparator OFF Voltage, $V_{DIS(OFF)}$ Figure 14. VCC Discharge Current, $I_{DIS(VCC)}$

TYPICAL CHARACTERISTICS

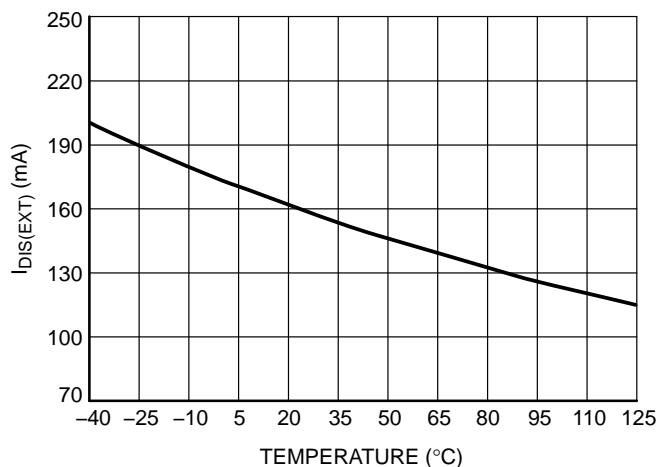


Figure 15. VCC Discharge Current, $I_{DIS(EXT)}$

APPLICATION INFORMATION

The NCP4371 is designed to operate as an output voltage and current controller for USB chargers, which resides on the secondary side of the off-line adapter. It enables to accommodate the output voltage based on the request from the portable device in order to optimize the battery charge time. The NCP4371 is compatible with Qualcomm Quick Charge 3.0 HVDPC specification. The output voltage can be increased or decreased in discrete steps. The output current is limited not to exceed the maximum power limit for given output voltage level. The internal discharge switch discharges the output capacitors to a safe voltage level in a case of the cable unplug.

Voltage Regulation

The Voltage Regulation Path eliminates a need for a voltage shunt regulator at the secondary side of the off-line supply. The voltage on VCC pin is divided by internal resistor divider (R_{VSNS_UP} , R_{VSNS_DWN}) and compared with the internal precise voltage reference V_{REFV} . The voltage difference is amplified by g_{mV} of the transconductance amplifier. The amplifier output current is connected to the DRIVE pin. This DRIVE pin drives regulation optocoupler that provides regulation of primary side. The internal voltage reference V_{REFV} is adjustable based on the command from the Portable Device compatible with Qualcomm Quick Charge specification. The voltage control loop compensation network shall be connected between DRIVE and COMP pins.

Current Regulation

The output current is sensed by the shunt resistor R_{SENSE} in series with the load. Voltage drop on R_{SENSE} is compared with internal precise voltage reference V_{REFC} at ISNS transconductance amplifier input. Voltage difference is amplified by g_{mC} to output current of amplifier, connected to the DRIVE pin.

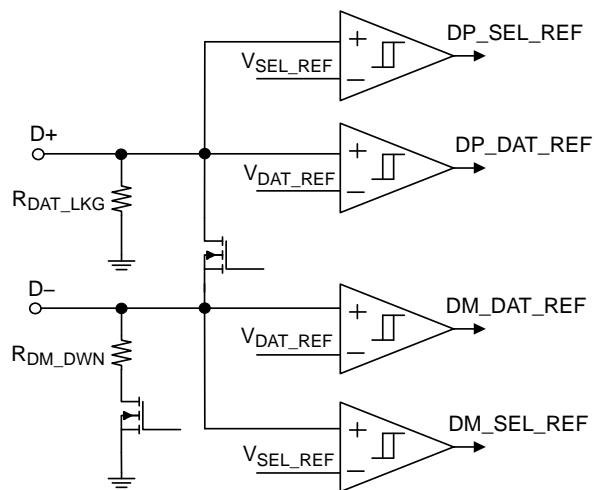
HVDPC Mode

After power-up pins D+ and D- of NCP4371 are shorted with impedance R_{DCP_DAT} and internal reference voltage V_{REFV} is set to V_{BUS} voltage 5 V. The device is in a BC1.2 compatible mode. If a portable device compatible with the Qualcomm Quick Charge specification is connected a negotiation between HVDPC and PD is executed. Once the negotiation is successful the NCP4371 opens D+ and D- short connection and D- is pulled down with a R_{DM_DWN} . The NCP4371 enters HVDPC mode. It monitors D+ and D- inputs. Based on the specified control patterns the internal voltage reference value V_{REFV} is adjusted in order to increase or decrease output voltage to the required value. The NCP4371 is available in Class A and Class B version. Class A allows to change the output voltage up to $V_{BUS} = 12$ V. Class B allows output voltage up to 20 V. If the unplug event is detected the decoder circuitry turns-on an internal current sink, which discharges the output capacitors to a safe voltage level. If the NCP4371 is set to a

Continuous mode it responds to the PD requests in a Single request mode. It does not support Group request mode.

Table 4. D+ AND D- OUTPUT VOLTAGE CODING

Portable Device	HVDPC Class A	HVDPC Class B
D+	D-	Adapter Voltage
0.6 V	0.6 V	12 V
3.3 V	0.6 V	9 V
0.6 V	3.3 V	Continuous mode
3.3 V	3.3 V	Previous voltage
0.6 V	GND	5 V

**Figure 16. HVDPC D+ and D- Comparators****HVDPC Mode – Continuous Mode**

The continuous mode of operation leverages the previously unused state in QC2.0. If the portable devices try and utilize this mode, it applies voltages on D+ and D- per Table 4. Assuming the HVDPC supports this mode of operation, it will glitch filter the request as it currently does, using $T_{GLITCH_V_CHANGE}$. Before the portable device can begin to increment or decrement the voltage, it must wait $T_{V_NEW_REQUEST_CONT}$ before pulling D+ and D- high or low. Once this time has finished, the portable device now attempts to increment or decrement the voltage. To increment, the portable device sends a pulse of width T_{ACTIVE} by pulling D+ to V_{DP_UP} and then must return D+ to V_{DP_SRC} for $T_{INACTIVE}$.

The NCP4371 responds to the increment/decrement request in a single request mode, i.e. the output voltage is changed immediately with each request. For the single request, and HVDPC recognizes a rising edge on D+ for an increment, and falling edge on D- for a decrement, and glitch filters this with $T_{GLITCH_CONT_CHANGE}$. After this period, it begins changing its output voltage by incrementing or decrementing in a 200 mV step. The output voltage is at its final value within $T_{V_CONT_CHANGE_SINGLE}$.

NCP4371

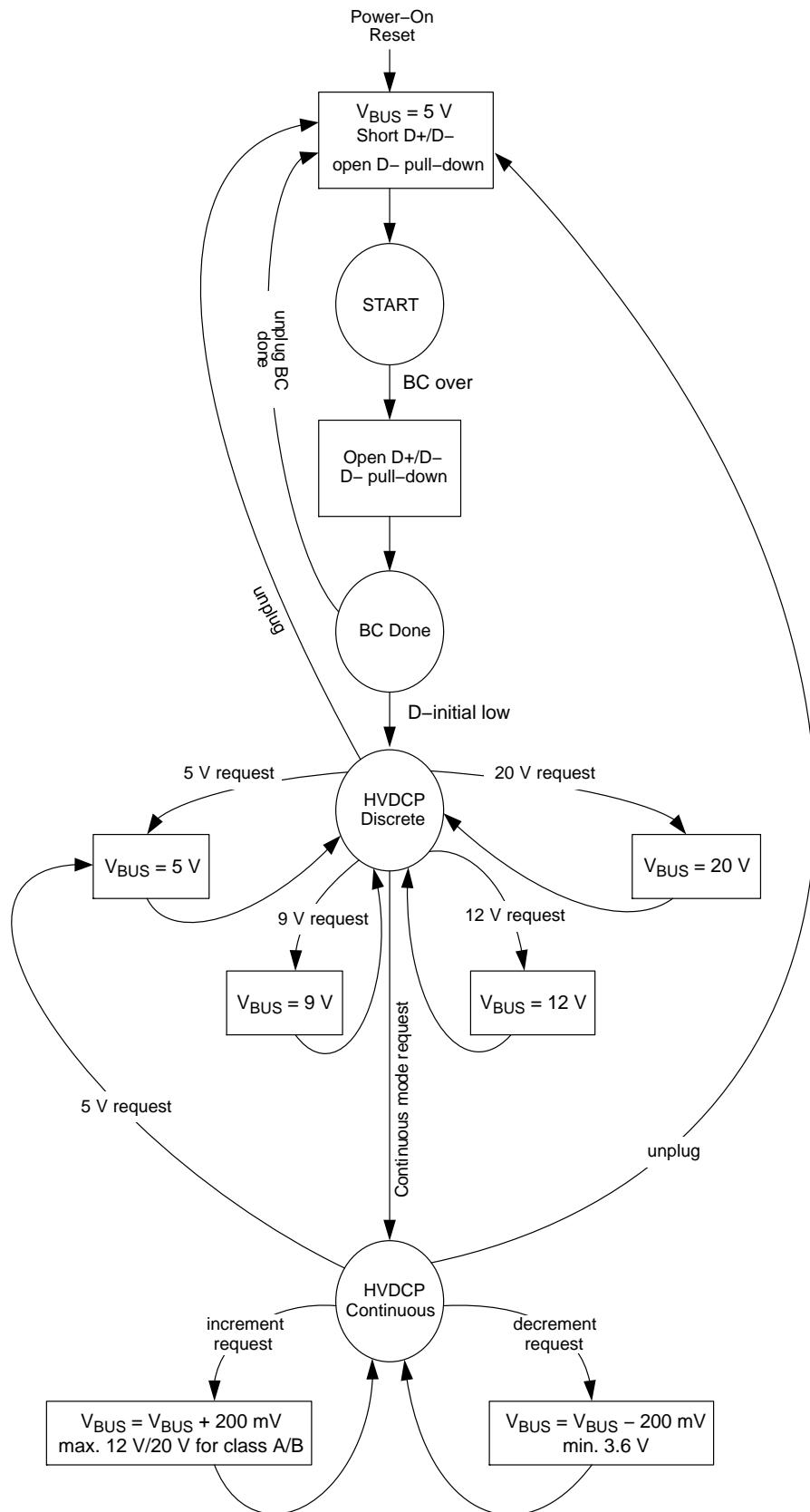


Figure 17. NCP4371 State Diagram

Power Limit

The protocol decoder and the power limit logic will limit maximum output current to keep regulation within recommended V_{out}/I_{out} operating range. The Power Limit block adjusts V_{REFC} voltage reference at the current regulation loop in order to limit the maximum output current.

The NCP4371 is designed to give a user a high degree of freedom to optimize maximum power and current limit profile of the target application. The user can scale both – maximum output power and maximum current limit independently.

The NCP4371 has two constant power curves defined – “Option A” for Class A only and “Option B” for either Class A or Class B. Power Option C shall be used for applications where constant power regulation is not required. If Power Option C is selected then power limiting curve is ignored. The applications based on Power Option C operate in “constant current regulation mode”.

In order to scale the power limit curve for the given power a selection of the current sense resistor has to be done. The relation between current sense resistor and output power limit is given by the curves in Figure 18.

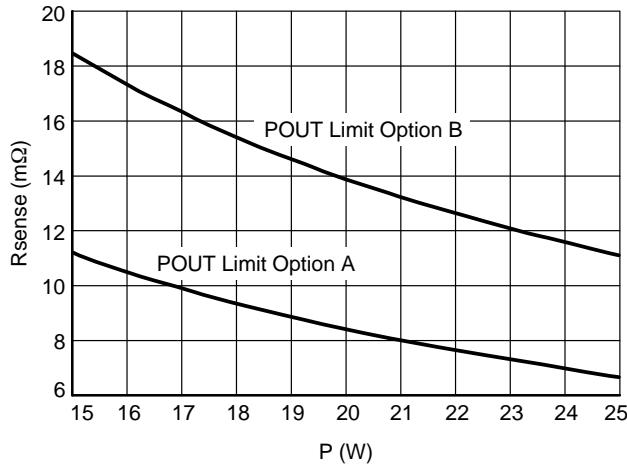


Figure 18. R_{SENSE} vs. P_{OUT} Limit Curve

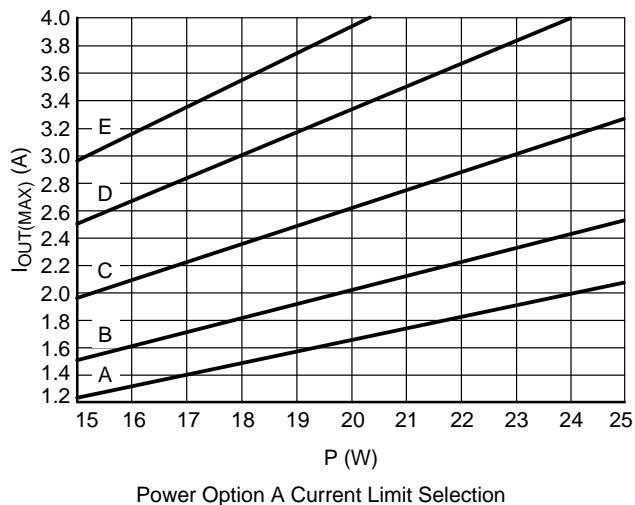
The characteristics in the Figure 23 cover a range $P_{OUT} = 15 - 25$ W. For powers outside this interval following formula can be used for R_{SENSE} selection:

$$\text{Option A (Class A only)} : R_{SENSE} = \frac{168}{P_{max}} [\text{m}\Omega] \quad (\text{eq. 1})$$

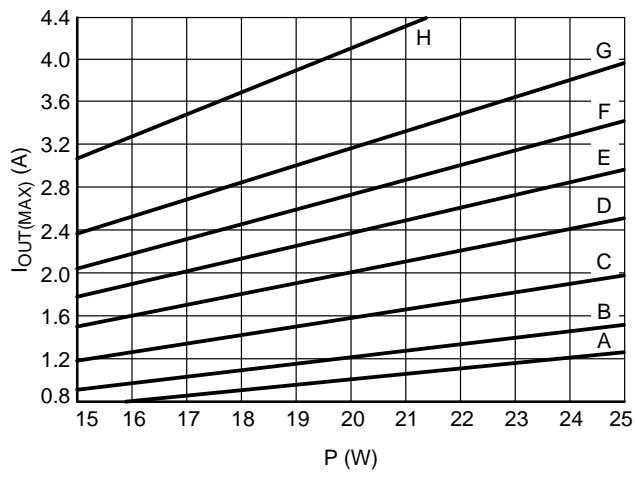
$$\text{Option B (Class A & B)} : R_{SENSE} = \frac{277}{P_{max}} [\text{m}\Omega] \quad (\text{eq. 2})$$

Once the Power limit is defined by an R_{SENSE} selection the user needs to define a maximum output current limit. This current limit can be given by a connector or cable maximum current rating.

There are 5 current limit options available for Power Option A and 8 current limit options for Power Option B and C. Each power limit option corresponds to a particular Current Control Reference Voltage (V_{REFC}), which limits the maximum output current for the selected R_{SENSE} resistor. The user has to make a selection from current limit characteristics shown in Figure 19. Each power limit curve represents a unique device option (see Table Device Options).



Power Option A Current Limit Selection



Power Option B Current Limit Selection

Figure 19. Current Limit Characteristics

Table 5. CURRENT LIMIT OPTION REFERENCE VOLTAGE

Current Limit Option	A	B	C	D	E	F	G	H
V _{REFC} [mV]	14	17	22	28	33	38	44	57

Soft Short-Circuit Protection

In case of a short-circuit at the USB cable end or the portable device USB receptacle it is desired to limit the short circuit current to prevent a portable device or cable from a damage. The NCP4371 offers an extended region of output current limiting down to $V_{BUS} = 2.2$ V. If the V_{BUS} falls below $V_{CC(OFF)}$ then the HVDPCP logic is disabled and D+/– pins are shorted. No further commands from the portable device are accepted. The only feature enabled is the output current limiting at the moment. The device stays in the current limiting mode until V_{CC} rises back above $V_{CC(ON)}$ threshold. The device logic will resume its operation and goes to a default BC1.2 compatible mode. A new negotiation between the charger and portable device has to be carried out in order to enable HVDCP compatibility mode.

Discharge

If voltage level lower than actual V_{BUS} is requested by PD the discharge circuitry discharges the output capacitors to reach the new voltage level in a short time. As well, the discharge circuitry is activated if cable unplug event is detected. The NCP4371 features two discharge paths. By default, the discharge is done via built-in regulated current source at V_{CC} pin. If the V_{CC} pin discharge capability is not sufficient an external discharge resistor R_{DIS} has to be used.

The discharge resistor is wired from a positive pole of the output capacitor to the **DISCHARGE** pin. The minimum recommended value of the discharge resistor R_{DIS} is $70\ \Omega$ for Class A and $120\ \Omega$ for Class B. The **DISCHARGE** pin has an internal protection for a case the user wires the pin directly to V_{BUS} . If this condition is detected the discharge MOSFET at the pin is turned off. It is highly recommended to use an external discharge resistor always if Class B device is used. In case of Class A device and $C_{OUT} < 1500\ \mu F$ the **DISCHARGE** pin can be left disconnected.

Dual Discharge Path

The NCP4371 allows to select between a single discharge path and the dual discharge. By default, if an external discharge resistor R_{DIS} is connected between a positive pole of the output capacitor and the DISCHARGE pin, the NCP4371 recognize it and the internal discharge path via VCC pin is disabled. Some applications may require even stronger discharge capability or may need to discharge two capacitors connected at two different nodes (USB-Type C output capacitors before and after VBUS switch). The NCP4371 allows to enable a simultaneous function of internal discharge via VCC pin and external DISCHARGE pin. Figure 20 shows an application idea of the dual discharge paths in the USB-Type C adapter design.

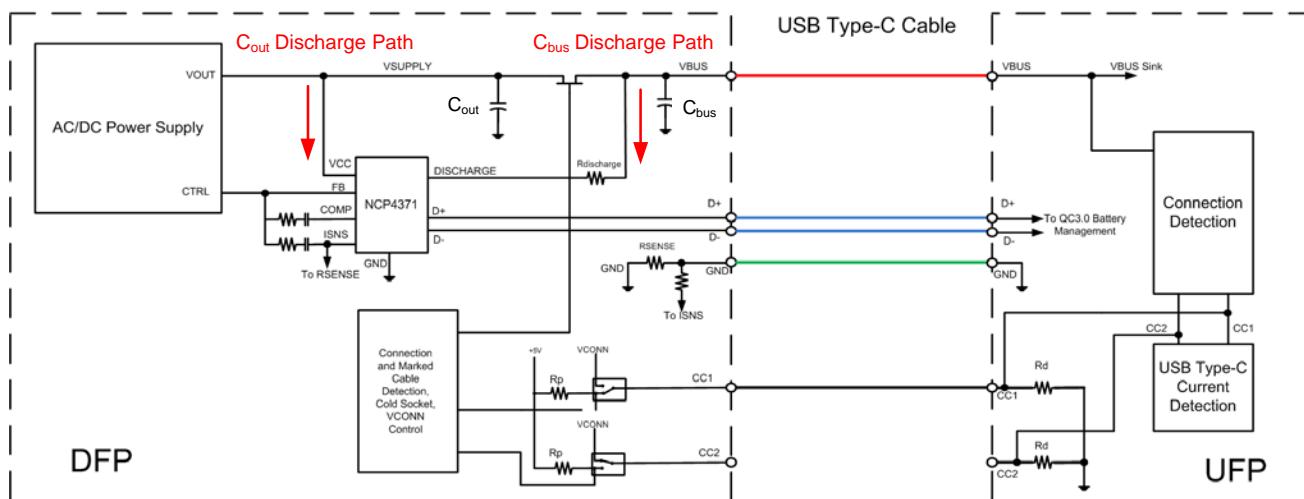


Figure 20. Dual Discharge Path – Application Idea (USB-Type C Adapter)

Table 6. DEVICE OPTIONS

OPN # NCP4371xyzwDR2G	QuickCharge Class A/B X		Power Limit Y			Current Limit (mV) Z								Discharge W	
	A	B	A	B	C	A	B	C	D	E	F	G	H	S	D
	Class A	Class B	Class A	Class A&B	No Power Limit	14	17	22	28	33	38	44	57	Single	Dual
NCP4371AACDR2G	X		X					X						X	
NCP4371AAEDR2G	X		X							X				X	
NCP4371AADDR2G	X		X						X					X	
NCP4371ACCDR2G	X				X			X						X	
NCP4371BBEDR2G		X		X						X				X	
NCP4371BBCDDR2G		X		X			X								X

NOTE: Device option with 4371XYZ marking are single discharge path version exclusively.

ORDERING INFORMATION

Device	Marking	Package	Shipping†
NCP4371AACDR2G	4371AAC	SOIC-8 (Pb-Free)	2500 / Tape & Reel
NCP4371AAEDR2G	4371AAE		
NCP4371AADDR2G	4371AAD		
NCP4371ACCDR2G	4371ACC		
NCP4371BBEDR2G	4371BBE		
NCP4371BBCDDR2G	4371BCD		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Qualcomm Quick Charge is a trademark of Qualcomm Incorporated.

MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS

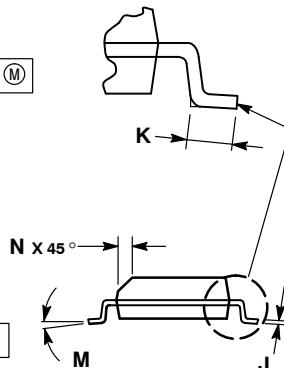
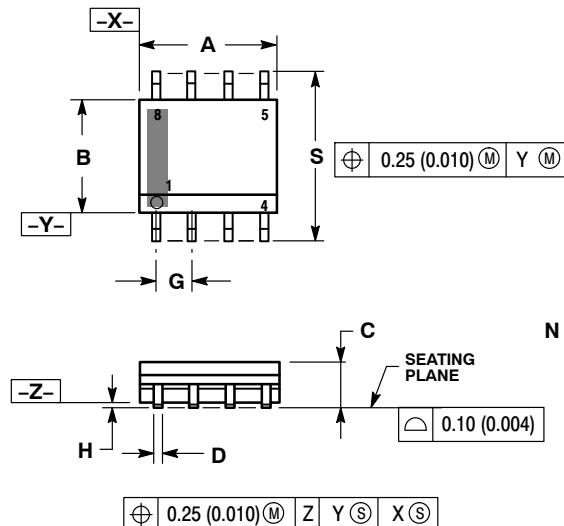
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SCALE 1:1

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ISSUE AK

DATE 16 FEB 2011

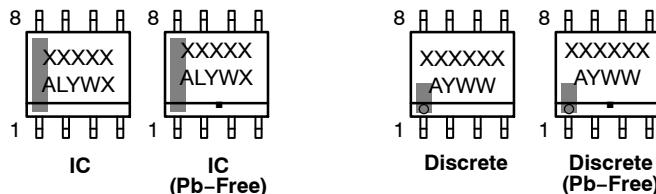


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. 751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.80	5.00	0.189	0.197
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.27 BSC		0.050 BSC	
H	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
M	0 °	8 °	0 °	8 °
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0.244

GENERIC MARKING DIAGRAM*



XXXXXX = Specific Device Code
A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week
▪ = Pb-Free Package

XXXXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
▪ = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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STYLE 1: PIN 1. Emitter 2. Collector 3. Collector 4. Emitter 5. Emitter 6. Base 7. Base 8. Emitter	STYLE 2: PIN 1. Collector, Die #1 2. Collector, #1 3. Collector, #2 4. Collector, #2 5. Base, #2 6. Emitter, #2 7. Base, #1 8. Emitter, #1	STYLE 3: PIN 1. Drain, Die #1 2. Drain, #1 3. Drain, #2 4. Drain, #2 5. Gate, #2 6. Source, #2 7. Gate, #1 8. Source, #1	STYLE 4: PIN 1. Anode 2. Anode 3. Anode 4. Anode 5. Anode 6. Anode 7. Anode 8. Common Cathode
STYLE 5: PIN 1. Drain 2. Drain 3. Drain 4. Drain 5. Gate 6. Gate 7. Source 8. Source	STYLE 6: PIN 1. Source 2. Drain 3. Drain 4. Source 5. Source 6. Gate 7. Gate 8. Source	STYLE 7: PIN 1. Input 2. External Bypass 3. Third Stage Source 4. Ground 5. Drain 6. Gate 3 7. Second Stage Vd 8. First Stage Vd	STYLE 8: PIN 1. Collector, Die #1 2. Base, #1 3. Base, #2 4. Collector, #2 5. Collector, #2 6. Emitter, #2 7. Emitter, #1 8. Collector, #1
STYLE 9: PIN 1. Emitter, Common 2. Collector, Die #1 3. Collector, Die #2 4. Emitter, Common 5. Emitter, Common 6. Base, Die #2 7. Base, Die #1 8. Emitter, Common	STYLE 10: PIN 1. Ground 2. Bias 1 3. Output 4. Ground 5. Ground 6. Bias 2 7. Input 8. Ground	STYLE 11: PIN 1. Source 1 2. Gate 1 3. Source 2 4. Gate 2 5. Drain 2 6. Drain 2 7. Drain 1 8. Drain 1	STYLE 12: PIN 1. Source 2. Source 3. Source 4. Gate 5. Drain 6. Drain 7. Drain 8. Drain
STYLE 13: PIN 1. N.C. 2. Source 3. Source 4. Gate 5. Drain 6. Drain 7. Drain 8. Drain	STYLE 14: PIN 1. N-Source 2. N-Gate 3. P-Source 4. P-Gate 5. P-Drain 6. P-Drain 7. N-Drain 8. N-Drain	STYLE 15: PIN 1. Anode 1 2. Anode 1 3. Anode 1 4. Anode 1 5. Cathode, Common 6. Cathode, Common 7. Cathode, Common 8. Cathode, Common	STYLE 16: PIN 1. Emitter, Die #1 2. Base, Die #1 3. Emitter, Die #2 4. Base, Die #2 5. Collector, Die #2 6. Collector, Die #2 7. Collector, Die #1 8. Collector, Die #1
STYLE 17: PIN 1. VCC 2. V2OUT 3. V1OUT 4. TXE 5. RXE 6. VEE 7. GND 8. ACC	STYLE 18: PIN 1. Anode 2. Anode 3. Source 4. Gate 5. Drain 6. Drain 7. Cathode 8. Cathode	STYLE 19: PIN 1. Source 1 2. Gate 1 3. Source 2 4. Gate 2 5. Drain 2 6. Mirror 2 7. Drain 1 8. Mirror 1	STYLE 20: PIN 1. Source (N) 2. Gate (N) 3. Source (P) 4. Gate (P) 5. Drain 6. Drain 7. Drain 8. Drain
STYLE 21: PIN 1. Cathode 1 2. Cathode 2 3. Cathode 3 4. Cathode 4 5. Cathode 5 6. Common Anode 7. Common Anode 8. Cathode 6	STYLE 22: PIN 1. I/O Line 1 2. Common Cathode/VCC 3. Common Cathode/VCC 4. I/O Line 3 5. Common Anode/GND 6. I/O Line 4 7. I/O Line 5 8. Common Anode/GND	STYLE 23: PIN 1. Line 1 IN 2. Common Anode/GND 3. Common Anode/GND 4. Line 2 IN 5. Line 2 OUT 6. Common Anode/GND 7. Common Anode/GND 8. Line 1 OUT	STYLE 24: PIN 1. Base 2. Emitter 3. Collector/Anode 4. Collector/Anode 5. Cathode 6. Cathode 7. Collector/Anode 8. Collector/Anode
STYLE 25: PIN 1. VIN 2. N/C 3. REXT 4. GND 5. IOUT 6. IOUT 7. IOUT 8. IOUT	STYLE 26: PIN 1. GND 2. dv/dt 3. Enable 4. ILIMIT 5. Source 6. Source 7. Source 8. VCC	STYLE 27: PIN 1. ILIMIT 2. OVLO 3. UVLO 4. INPUT+ 5. Source 6. Source 7. Source 8. Drain	STYLE 28: PIN 1. SW_TO_GND 2. DASIC_OFF 3. DASIC_SW_DET 4. GND 5. V_MON 6. VBUCK 7. VBUCK 8. VIN
STYLE 29: PIN 1. Base, Die #1 2. Emitter, #1 3. Base, #2 4. Emitter, #2 5. Collector, #2 6. Collector, #2 7. Collector, #1 8. Collector, #1	STYLE 30: PIN 1. Drain 1 2. Drain 1 3. Gate 2 4. Source 2 5. Source 1/Drain 2 6. Source 1/Drain 2 7. Source 1/Drain 2 8. Gate 1		

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